

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Shunpei Yamazaki</td><td>03/10/2009</td></tr><tr><td>Akihisa Shimomura</td><td>03/11/2009</td></tr></tbody></table>	Name	Execution Date	Shunpei Yamazaki	03/10/2009	Akihisa Shimomura	03/11/2009	
Name	Execution Date						
Shunpei Yamazaki	03/10/2009						
Akihisa Shimomura	03/11/2009						
RECEIVING PARTY DATA							
Name:	Semiconductor Energy Laboratory Co., Ltd.						
Street Address:	398, Hase						
City:	Atsugi-shi, Kanagawa-ken						
State/Country:	JAPAN						
Postal Code:	243-0036						
PROPERTY NUMBERS Total: 1							
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12405465</td></tr></tbody></table>	Property Type	Number	Application Number:	12405465			
Property Type	Number						
Application Number:	12405465						
CORRESPONDENCE DATA							
Fax Number:	(571)434-9499						
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
Phone:	(571) 434-6789						
Email:	scarr@riplo.com						
Correspondent Name:	Eric J. Robinson						
Address Line 1:	Robinson IP Law Office, P.C.						
Address Line 2:	21010 South Street, PMB 955						
Address Line 4:	Potomac Falls, VIRGINIA 20165						
ATTORNEY DOCKET NUMBER:	0756-8505						
NAME OF SUBMITTER:	Eric J. Robinson						
Total Attachments: 2 source=assignment#page1.tif source=assignment#page2.tif							

OP \$40.00 12405465

PATENT

500808991

REEL: 022405 FRAME: 0949

ASSIGNMENT

Serial No. _____

Filed _____

WHEREAS, Shunpei YAMAZAKI and Akihisa SHIMOMURA
(hereinafter designated as the undersigned) has (have) invented certain new and useful
improvements in PHOTOELECTRIC CONVERSION DEVICE AND METHOD FOR
MANUFACTURING THE SAME for which an application for Letters Patent of the United
States of America has been executed by the undersigned on _____, and;

WHEREAS, Semiconductor Energy Laboratory Co., Ltd. of 398, Hase, Atsugi-shi,
Kanagawa-ken, 243-0036 Japan and its heirs, successors, legal representatives and assigns
(hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and
interest in and to said invention and in and to any Letters Patent(s) that may be granted
therefor in the United States of America;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the
undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and
valuable consideration, the undersigned has (have) sold, assigned and transferred, and by
these presents do sell, assign and transfer unto said Assignee the full and exclusive right to the
said invention in the United States of America and its territories and for all foreign countries,
dependencies and possessions and the entire right, title and interest in and to any and all
Letters Patent(s) which may be granted therefor in the United States of America and its
territories, dependencies and possessions, and in and to any and all divisions, reissues,
continuations and extensions thereof for the full term or terms for which the same may be
granted.

The undersigned agree(s) to execute all papers necessary in connection with this
application and any continuing, divisional or reissue applications thereof and also to execute
separate assignments in connection with such applications as the Assignee may deem
necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any
interference which may be declared concerning this application or any continuation, division
or reissue thereof or Letters Patent(s) or reissue patent issued thereon and to cooperate with
the Assignee in every way possible in obtaining and producing evidence and proceeding with
such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act
which may be necessary in connection with claims under or provisions of the International
Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to
obtain a grant of a valid United States patent(s) to the Assignee and to vest all rights therein
hereby conveyed to said Assignee as fully and entirely as the same would have been held by
the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Commissioner of Patents and

Trademarks to issue any and all Letters Patents of the United States of America resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of ROBINSON INTELLECTUAL PROPERTY LAW OFFICE the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

In witness thereof, this Assignment has been executed by the undersigned on the date(s) opposite the undersigned name(s).

Date 03/10/2009

Signature 
Name Shunpei YAMAZAKI

Date 03/11/2009

Signature Akihisa SHIMOMURA
Name Akihisa SHIMOMURA

This assignment should preferably be acknowledged before a United States Consul or Notary Public. If not, then the execution by the Inventor(s) should be witnessed has (have) invented certain new and useful improvements in by at least two other persons who should sign here.

Witness _____

Signature _____

Witness _____

Signature _____

Witness _____

Signature _____